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1204.44601X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MATSUURA, et al.
Application No.: 10/519,713
Filed: December 30, 2004
For: ADHESIVE FILM FOR SEMICONDUCTOR USE, METAL SHEET LAMINATED WITH ADHESIVE FIL, WIRING CIRCUIT LAMINATED WITH ADHESIVE FILM, AND SEMICONDUCTOR
Group: 2823
Examiner: Julio J. Maldonado
Confirm. No.: 7508

AMENDMENT

Mail Stop: Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

February 16, 2007

Sir:

In response to the Office Action mailed November 16, 2006, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Claims; and

Remarks are included following the amendments.